

Electronic Acknowledgement Receipt

EFS ID:	2936321
Application Number:	10823970
International Application Number:	
Confirmation Number:	5318
Title of Invention:	Semiconductor device having a pad metal layer and a lower metal layer that are electrically coupled, whereas apertures are formed in the lower metal layer below a center area of the pad metal layer
First Named Inventor/Applicant Name:	Hiroyuki Ogawa
Customer Number:	71326
Filer:	Reginald A. Ratliff/Christina Holland
Filer Authorized By:	Reginald A. Ratliff
Attorney Docket Number:	AMD-AFO1215
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Application Type:	Utility under 35 USC 111(a)

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Submitted with Payment	yes
Payment Type	Electronic Funds Transfer
Payment was successfully received in RAM	\$ 810
RAM confirmation Number	3703
Deposit Account	
Authorized User	

File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
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1		SPSN-AF01215.pdf	82587 3cef1128bdbae66ea35143ef7c17b6ee738070d8	yes	10
	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Amendment Submitted/Entered with Filing of CPA/RCE		1	1	
	Claims		2	4	
	Applicant Arguments/Remarks Made in an Amendment		5	10	
Warnings:					
Information:					
2	Fee Worksheet (PTO-06)	fee-info.pdf	8276 145040352648514fc36ab823c00a6e1fb9c2392f	no	2
Warnings:					
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Total Files Size (in bytes):			90863		
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p> <p><u>New International Application Filed with the USPTO as a Receiving Office</u> If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.</p>					